

Chip resistor networks

MNR34 (3216 × 4 size)

●Features

- 1) Convex electrodes

Easy to check the fillet after soldering is finished.
- 2) Compatible with a wide range of mounting equipment.

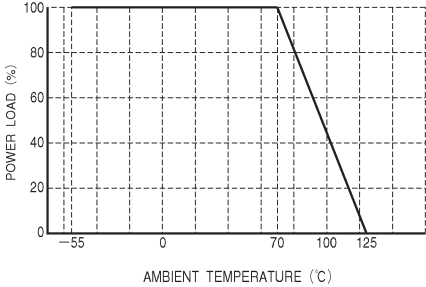
Squared corners make it excellent for mounting using image recognition devices.
- 3) High-density mounting

Can be mounted even more densely than four 3216
- chips (MCR18). Also, the number of parts and cost of mounting have been reduced.

4) ROHM resistors have approved ISO-9001 certification.

Design and specifications are subject to change without notice. Carefully check the specification sheet supplied with the product before using or ordering it.

●Ratings

Item	Conditions	Specifications	
Rated power	<div>Power must be derated according to the power derating curve in Figure 1 when ambient temperature exceeds 70°C.</div> <div></div> <div>Fig.1</div>	0.125W (1 / 8W) at 70°C	
Rated voltage	<div>The voltage rating is calculated by the following equation. If the value obtained exceeds the maximum operating voltage, the voltage rating is equal to the maximum operating voltage.</div> <div>$E = \sqrt{P \times R}$<div><div>E: Rated voltage (V)</div><div>P: Rated power (W)</div><div>R: Nominal resistance (Ω)</div></div></div>	Max. operating voltage	200V
		Max. overload voltage	400V
		Max. intermittent overload voltage	400V
Nominal resistance	See Table 1.		
Operating temperature		-55°C to +125°C	

Jumper type

Resistance	Max. 50mΩ
Rated current	2A
Peak current	10A
Operating temperature	−55°C to +125°C

Table 1

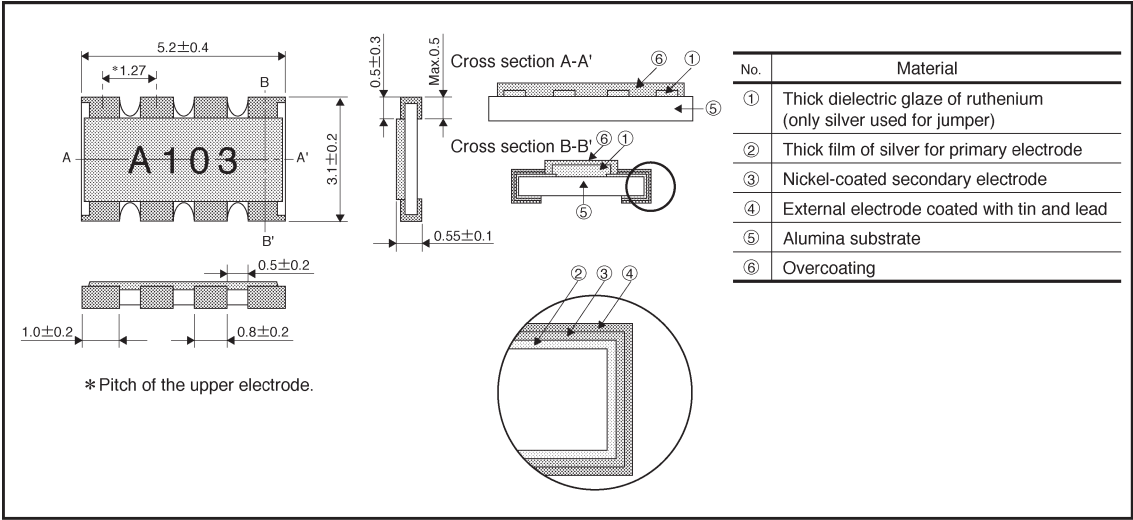
Resistance tolerance	Resistance range (Ω)	Resistance temperature coefficient (ppm / °C)
J (±5%)	10≤R≤1M (E24)	±200

●Before using components in circuits where they will be exposed to transients such as pulse loads (short-duration, high-level loads), be certain to evaluate the component in the mounted state. In addition, the reliability and performance of this component cannot be guaranteed if it is used with a steady state voltage that is greater than its rated voltage.

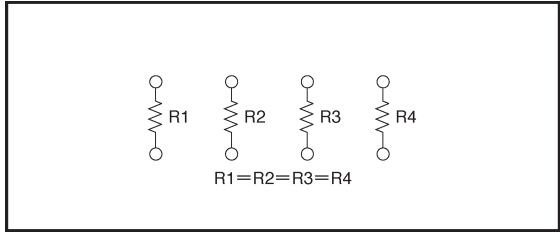
●Characteristics

Characteristics	Specifications		Test method (JIS C 5202)
	Chip resistance	Jumper type	
DC resistance	J : ±5%	Max. 50mΩ	JIS C 5202 5.1 Applied voltage: A
Resistance temperature characteristics	See Table 1.		JIS C 5202 5.2 Test conditions: +25 / −55 / +25 / +125°C
Short-time overload	± (5.0%+0.1Ω)	Max. 50mΩ	JIS C 5202 5.5 Rated voltage (current) : ×2.5, 5s. Maximum overload voltage: 400V
Resistance to soldering heat	± (2.5%+0.1Ω) Outside must not be noticeably damaged.	Max. 50mΩ	JIS C 5202 6.4 Soldering conditions: 260±5°C Soldering time: 10±1s.
Solderability	95% of terminal surface must be covered by new soldering, and there must be no soldering corrosion.		JIS C 5202 6.5 Rosin methanol: (25%WT) Soldering conditions: 235±5°C Soldering time: 2±0.5s.
Resistance to dry heat	± (5.0%+0.1Ω)	Max. 100mΩ	JIS C 5202 7.2 125°C Test time: 1,000 to 1,048 hrs.
Endurance (rated load)	± (5.0%+0.1Ω)	Max. 100mΩ	JIS C 5202 7.10 Rated voltage (current), 70°C 1.5h: ON — 0.5h: OFF Test time: 1,000 to 1,048 hrs.
Endurance (under load in damp environment)	± (5.0%+0.1Ω)	Max. 100mΩ	JIS C 5202 7.9 Rated voltage (current), 60°C, 95%RH 1.5h: ON — 0.5h: OFF Test time: 1,000 to 1,048 hrs.
Resistance to humidity (steady state)	± (5.0%+0.1Ω)	Max. 100mΩ	JIS C 5202 7.5 85°C, 85%RH Test time: 1,000 to 1,048 hrs.
Temperature cycling	± (2.5%+0.1Ω)	Max. 50mΩ	JIS C 5202 7.4 Test temperature: −55°C to +125°C 100cyc.
Resistance to solvents	± (1.0%+0.05Ω) Markings must not be dissolved away.	Max. 50mΩ	JIS C 5202 6.9 Room temperature, static immersion, 1 min. Solvent: Isopropyl alcohol

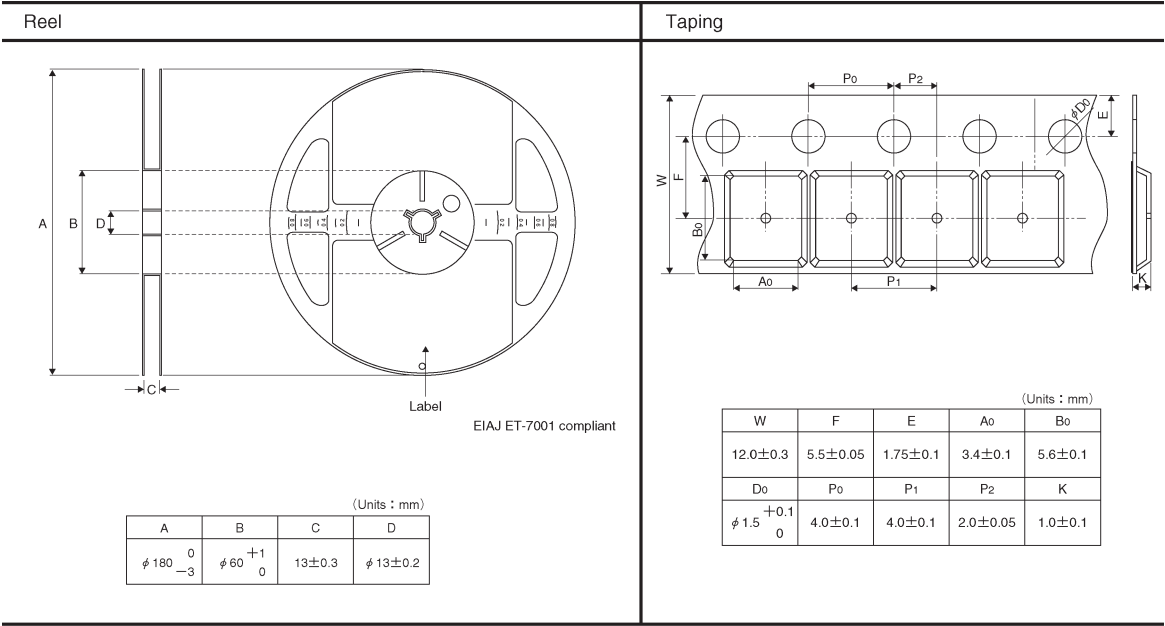
●External dimensions (Units: mm)



●Equivalent circuit



●Packaging



●Product designation

Part No.



Packaging / Processing specifications

Circuit configuration code

Resistance tolerance

Nominal resistance

Code	Part No.	Packaging	Package style
J5	MNR34	Taping	Embossed reel

AB	MNR34
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J	±5%
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3-digit IEC coding system

●Electrical characteristics

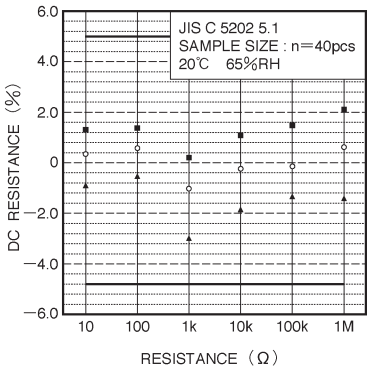


Fig.2 DC resistance

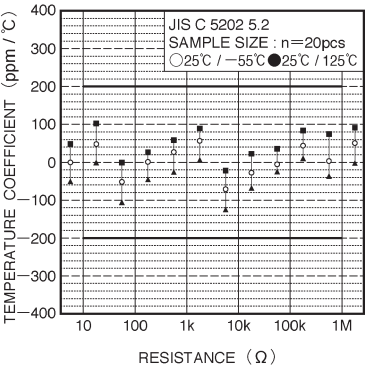


Fig.3 Resistance temperature characteristics

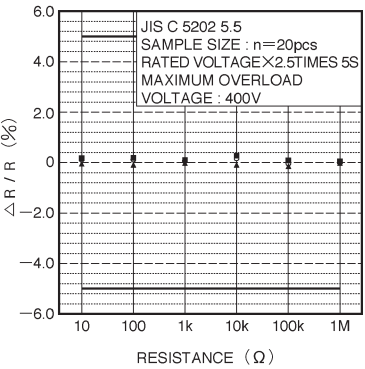


Fig.4 Short time overload

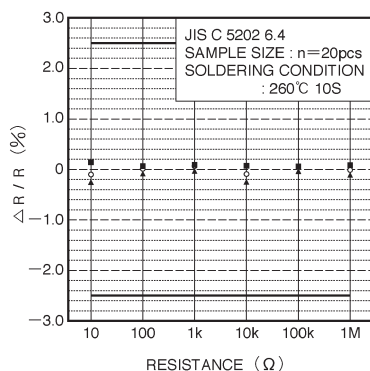


Fig.5 Resistance to soldering heat

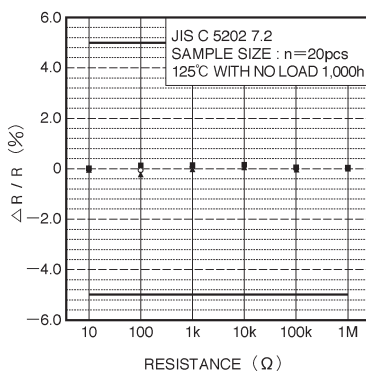


Fig.6 Resistance to dry heat

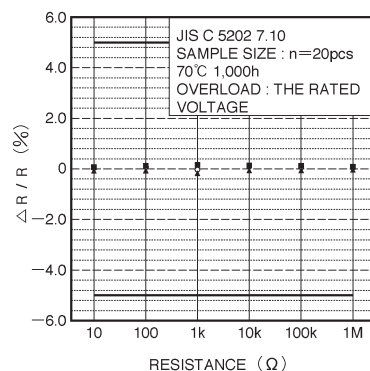


Fig.7 Endurance (rated load)

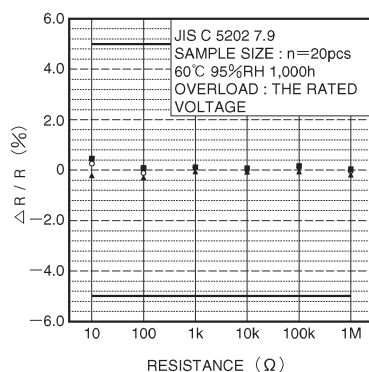


Fig.8 Endurance (under load in damp environment)

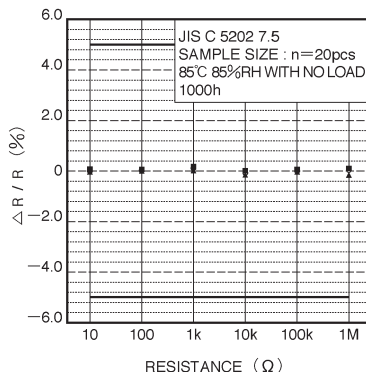


Fig.9 Resistance to humidity (steady state)

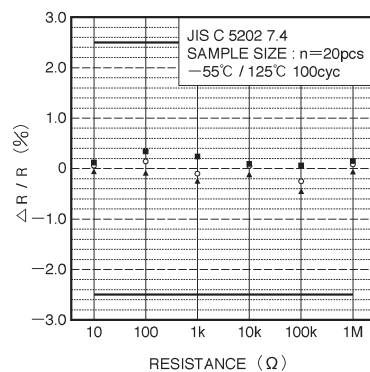


Fig.10 Temperature cycling (steady state)

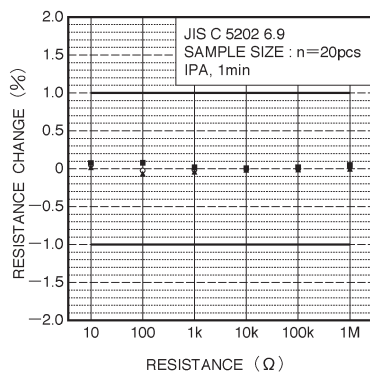


Fig.11 Resistance to solvents